



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 1653

SERIAL NUMBER 10/785,122	FILING DATE 02/24/2004 RULE	CLASS 257	GROUP ART UNIT 2815	ATTORNEY DOCKET NO. 5165.1US (01-0947.01/US)
-----------------------------	-----------------------------------	--------------	------------------------	---

APPLICANTS

Frank L. Hall, Boise, ID;

Cary J. Baerlocher, Meridian, ID;

** CONTINUING DATA *****

This application is a DIV of 10/191,655 07/08/2002 *[Signature]*

** FOREIGN APPLICATIONS *****

None *[Signature]*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 05/19/2004

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 5	TOTAL CLAIMS 42	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	<i>[Signature]</i>	<i>[Initials]</i>			

ADDRESS

24247
TRASK BRITT
P.O. BOX 2550
SALT LAKE CITY, UT
84110

TITLE

Underfilled, encapsulated semiconductor die assemblies and methods of fabrication

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
RECEIVED 1166		